

Chopper-Stabilized, Precision Hall-Effect Switch

Features and Benefits

- Resistant to physical stress
- Superior temperature stability
- Output short-circuit protection
- Operation from unregulated supply
- Reverse battery protection
- Solid-state reliability
- Small size

Packages: 3 pin SOT23W (suffix LH), and 3 pin SIP (suffix UA)



Not to scale

Description

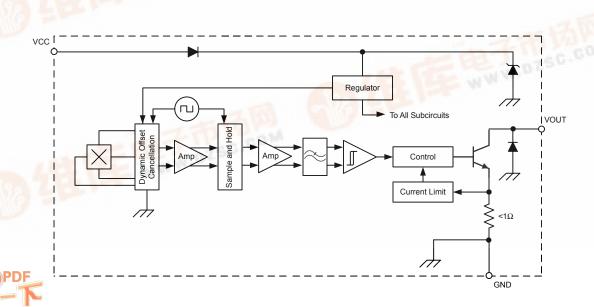
The A3340 Hall effect switch is an extremely temperature-stable and stress-resistant sensor especially suited for operation over extended temperature ranges up to 150°C. Superior high-temperature performance is made possible through dynamic offset cancellation, which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress.

The device includes on a single silicon chip a voltage regulator, Hall-voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short-circuit protected open-collector output to sink up to 25 mA. A south pole of sufficient strength will turn the output off. An on-board regulator permits operation with supply voltages of 4.2 to 24 volts.

Two package styles provide a magnetically optimized package for most applications. Suffix LH is an SOT23W surface mount package and while suffix UA is a three-lead ultramini SIP for through hole mounting.

The A3340 complements the A3240, which offers the same features, but with the opposite output polarity.

Functional Block Diagram



A3340

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Selection Guide						
Part Number	Packing*	Mounting	Ambient, T _A	B _{RP} (Min)	B _{OP} (Max)	
A3340ELHLT-T	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount	400C to 050C	to 85°C 5 o 150°C	50	
A3340EUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole	-40°C 10 65°C			
A3340LLHLT-T	7-in. reel, 3000 pieces/reel	3-pin SOT23W surface mount	4000 to 45000			
A3340LUA-T	Bulk, 500 pieces/bag	3-pin SIP through hole	-40°C to 150°C			

^{*}Contact Allegro for additional packing options.



Absolute Maximum Ratings

Characteristic	Symbol	Notes	Rating	Units
Supply Voltage	V _{cc}		26.5	٧
Reverse Supply Voltage	V _{RCC}		-30	V
Output Off Voltage	V _{OUT}		26	V
Reverse Output Voltage	V _{ROUT}		-0.5	V
Continuous Output Current	I _{OUT}	Internal current limiting (intended to protect the device from output short circuits)	25	mA
Reverse Output Current	I _{ROUT}		– 50	mA
Magnetic Flux Density	В		Unlimited	G
Operating Ambient Temperature	T _A	Range E	-40 to 85	°C
Operating Ambient Temperature		Range L	-40 to 150	°C
Maximum Junction Temperature	T _J (max)		165	°C
Storage Temperature	T _{stg}		-65 to 170	°C

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Operating Characteristics, valid over TA, unless otherwise noted

Characteristic	Symbol	Test Conditions	Min.	Typ. ¹	Max.	Units
Electrical Characteristics				•		
Supply Voltage Range ²	V _{CC}	Operating, T _J < 165°C	4.2	_	24	V
Output Leakage Current	I _{OFF}	V _{OUT} = 24 V, B > B _{OP}	_	_	10	μA
Output Saturation Voltage	V _{OUT(SAT)}	I _{OUT} = 20 mA, B < B _{RP}	_	185	500	mV
Output Current Limit	I _{OM}	B > B _{OP}	30	_	60	mA
Power-On Time	t _{PO}	V _{CC} > 4.2 V	_	_	50	μs
Chopping Frequency	f _C		_	340	_	kHz
Output Rise Time	t _r	R_{LOAD} = 820 Ω , C_{LOAD} = 20 pF	_	0.2	2.0	μs
Output Fall Time	t _f	R_{LOAD} = 820 Ω , C_{LOAD} = 20 pF	_	0.1	2.0	μs
Supply Current	I _{CC}	B < B _{RP} , V _{CC} = 12 V	_	3.0	6.0	mA
		B > B _{OP} , V _{CC} = 12 V	_	4.0	6.0	mA
Reverse Battery Current	I _{RCC}	V _{RCC} = -30 V	_	_	-5.0	mA
Zener Voltage	V _{ZD}	$V_Z + V_D$, $I_{CC} = 15$ mA, $T_A = 25$ °C	28	32	37	V
Zener Impedance	Z _{ZD}	$Z_Z + Z_D$, $I_{CC} = 15$ mA, $T_A = 25$ °C	_	50	_	Ω
Magnetic Characteristics ³						
Operate Point ⁴	B _{OP}		_	35	50	G
Release Point ⁴	B _{RP}		5.0	25	_	G
Hysteresis	B _{hys}	B _{OP} – B _{RP}		6	_	G

 $^{^{1}}$ Typical data are for initial design estimations only, and assume optimum manufacturing and application conditions, such as T_A = 25°C and V_{CC} =

¹² V. Performance may vary for individual units, within the specified maximum and minimum limits.

 $^{^2\}text{Maximum}$ voltage must be adjusted for power dissipation and junction temperature. 31 G (gauss) = 0.1 mT (millitesla).

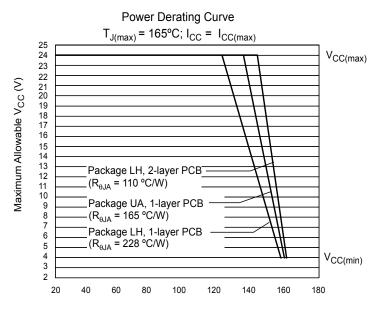
 $^{^{3}}B_{OP}$ = operate point (output turns off); B_{RP} = release point (output turns on).

A3340

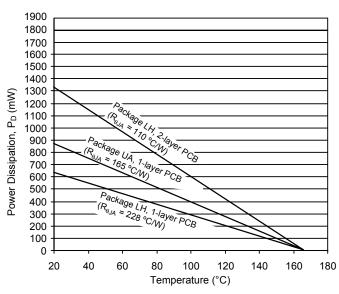
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THERMAL CHARACTERISTICS may require derating at maximum conditions, see application information

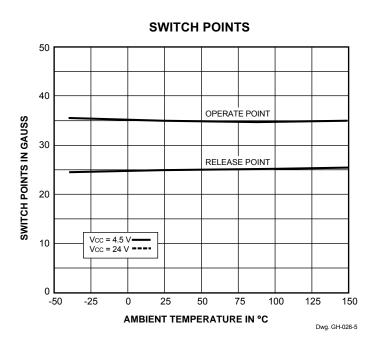
Characteristic	Symbol	Test Conditions		Units
		Package LH, 1-layer PCB with copper limited to solder pads	228	°C/W
Package Thermal Resistance	$R_{ heta JA}$	Package LH, 2-layer PCB with 0.463 in 2 of copper area each side connected by thermal vias		°C/W
		Package UA, 1-layer PCB with copper limited to solder pads	165	°C/W

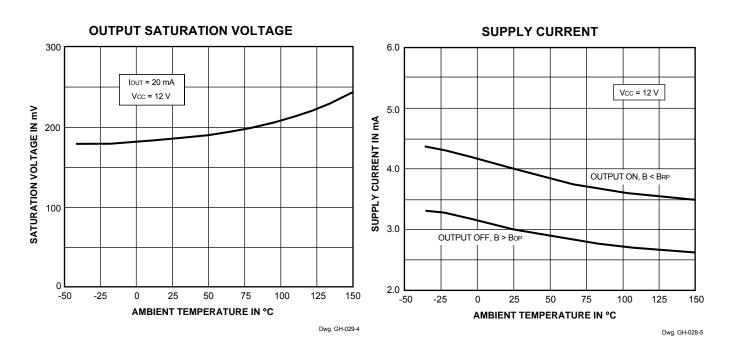


Power Dissipation versus Ambient Temperature



TYPICAL OPERATING CHARACTERISTICS as a function of temperature

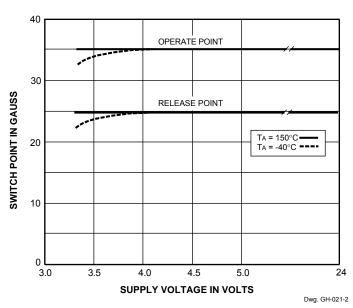




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TYPICAL OPERATING CHARACTERISTICS as a function of supply voltage

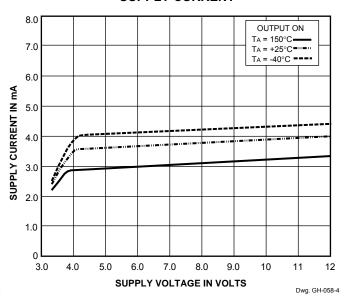
SWITCH POINTS



OUTPUT SATURATION VOLTAGE

250 | Ta = 150°C | Ta = 20 mA | Ta = 150°C | Ta = 25°C | Ta = -40°C |

SUPPLY CURRENT



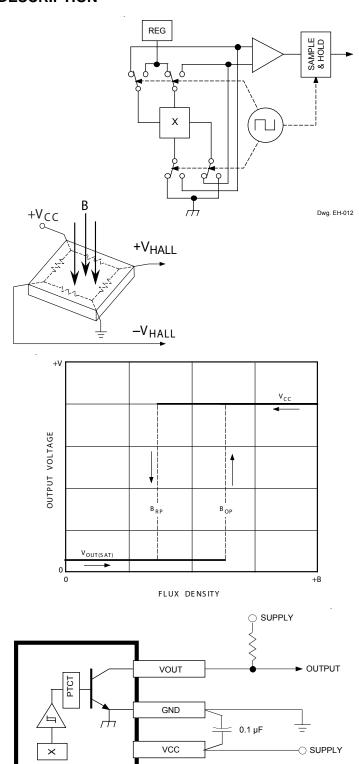
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FUNCTIONAL DESCRIPTION

Chopper-Stabilized Technique. The Hall element can be considered as a resistor array similar to a Wheatstone bridge. A large portion of the offset is a result of the mismatching of these resistors. These devices use a proprietary dynamic offset cancellation technique, with an internal high-frequency clock to reduce the residual offset voltage of the Hall element that is normally caused by device overmolding, temperature dependencies, and thermal stress. The chopper-stabilizing technique cancels the mismatching of the resistor circuit by changing the direction of the current flowing through the Hall plate using CMOS switches and Hall voltage measurement taps, while maintaing the Hallvoltage signal that is induced by the external magnetic flux. The signal is then captured by a sample-andhold circuit and further processed using low-offset bipolar circuitry. This technique produces devices that have an extremely stable quiescent Hall output voltage, are immune to thermal stress, and have precise recoverability after temperature cycling. This technique will also slightly degrade the device output repeatability. A relatively high sampling frequency is used in order that faster signals can be processed.

More detailed descriptions of the circuit operation can be found in: Technical Paper STP 97-10, Monolithic Magnetic Hall Sensor Using Dynamic Quadrature Offset Cancellation and Technical Paper STP 99-1, Chopper-Stabilized Amplifiers With A Track-and-Hold Signal Demodulator. Operation. The output of these devices switches high (turns off) when a magnetic field (south pole) perpendicular to the Hall sensor exceeds the operate point threshold (B_{OP}). When the magnetic field is reduced below the release point (B_{RP}) , the device output goes low (turns on). After turn-on, the output is capable of sinking 25 mA and the output voltage is V_{OUT(SAT)}. The difference in the magnetic operate and release points is the hysteresis (B_{hys}) of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise. Applications. It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall sensor) between the supply and ground of the device to reduce both external noise and noise generated by the chopperstabilization technique.

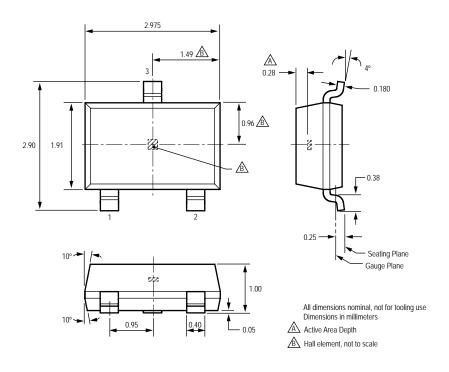
The simplest form of magnet that will operate these devices is a ring magnet. Other methods of operation, such as linear magnets, are possible. Extensive applications information on magnets and Hall-effect sensors is also available in Application Note 27701, or at www.allegromicro.com.



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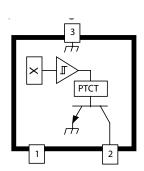
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Package LH, 3-Pin (SOT-23W)

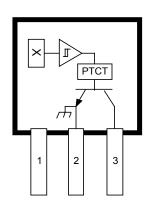


Pin-out Diagrams

Package LH



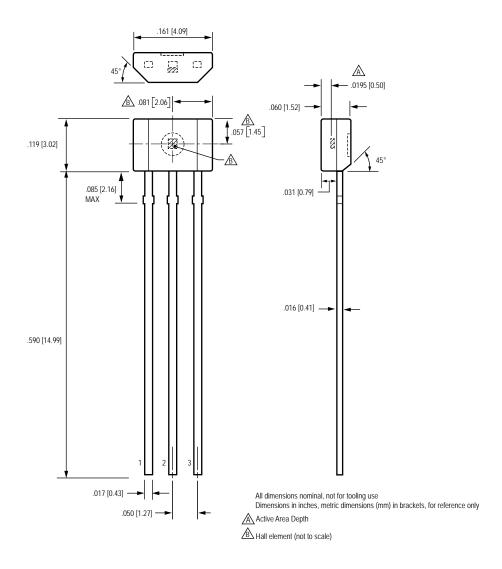
Package UA



Terminal List

Name	Description	Nur	Number		
Name	Description	Package LH	Package UA		
VCC	Connects power supply to chip	1	1		
VOUT	Output from circuit	2	3		
GND	Ground	3	2		

Package UA, 3-Pin SIP



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